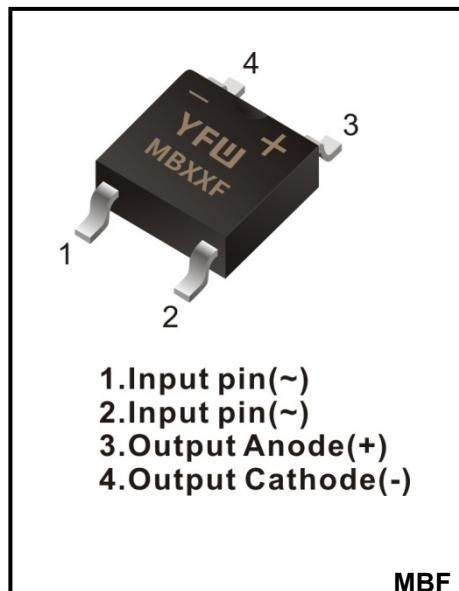


2A SURFACE MOUNT SCHOTTKY BRIDGE
RECTIFIER Reverse Voltage - 40 to 200 V
Forward Current - 2A
FEATURES

- ◆ High current capability
- ◆ Low forward voltage drop
- ◆ Low power loss, high efficiency
- ◆ Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

- ◆ Case: MBF
- ◆ Terminals: Solderable per MIL-STD-750, Method 2026
- ◆ Approx. Weight: 88mg / 0.0031oz


Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	MB24F	MB26F	MB28F	MB210F	MB220F	Units						
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	40	60	80	100	200	V						
Maximum RMS voltage	V_{RMS}	28	42	56	70	140	V						
Maximum DC Blocking Voltage	V_{DC}	40	60	80	100	200	V						
Average Rectified Output Current	$I_{F(AV)}$	2					A						
Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Superimposed on Rated Load(JEDEC method)	I_{FSM}	50		40			A						
Max Instantaneous Forward Voltage at 2 A	V_F	0.55	0.70	0.85			V						
Maximum DC Reverse Current @ $T_A=25^\circ\text{C}$ at Rated DC Blocking Voltage @ $T_A=100^\circ\text{C}$	I_R	0.5 10		0.3 5		μA							
Typical Junction Capacitance (Note1)	C_J	220	80				pF						
Typical Thermal Resistance (Note2)	$R_{\theta JA}$	75					$^\circ\text{C}/\text{W}$						
Operating and Storage Temperature Range	T_j	-55 ~ +125					$^\circ\text{C}$						
Storage Temperature Range	T_{stg}	-55 ~ +150					$^\circ\text{C}$						

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) Mounted on glass epoxy PC board with 4×1.5"×1.5" (3.81×3.81 cm) copper pad.

Fig.1 Forward Current Derating Curve

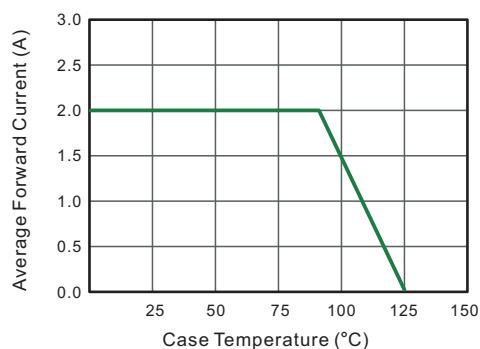


Fig.2 Typical Reverse Characteristics

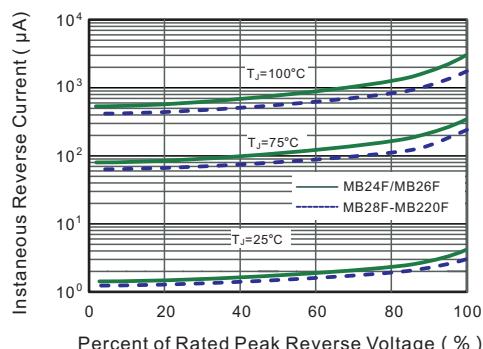


Fig.3 Typical Forward Characteristic

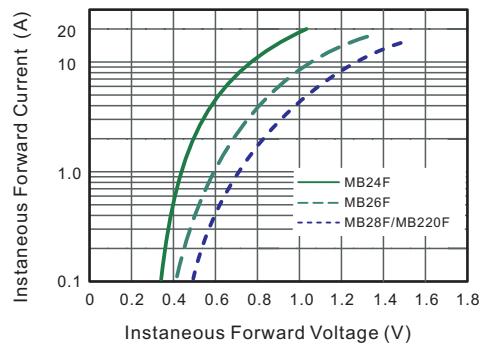


Fig.4 Typical Junction Capacitance

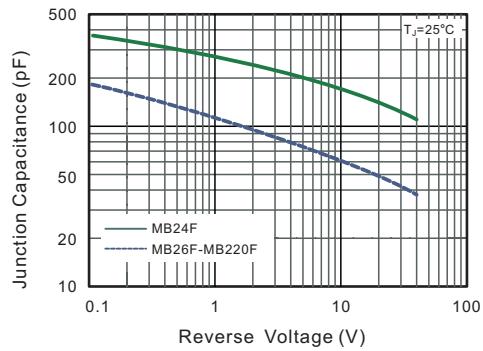


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

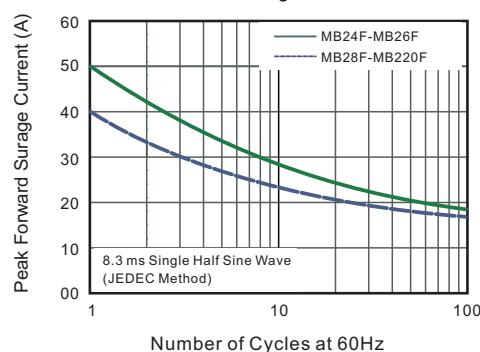
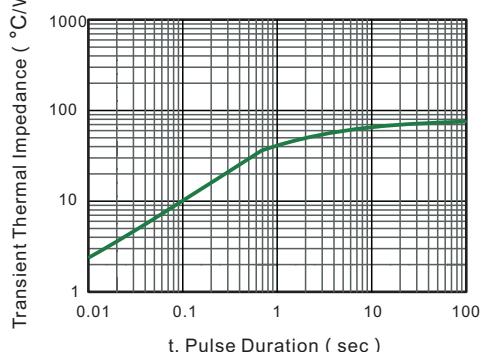


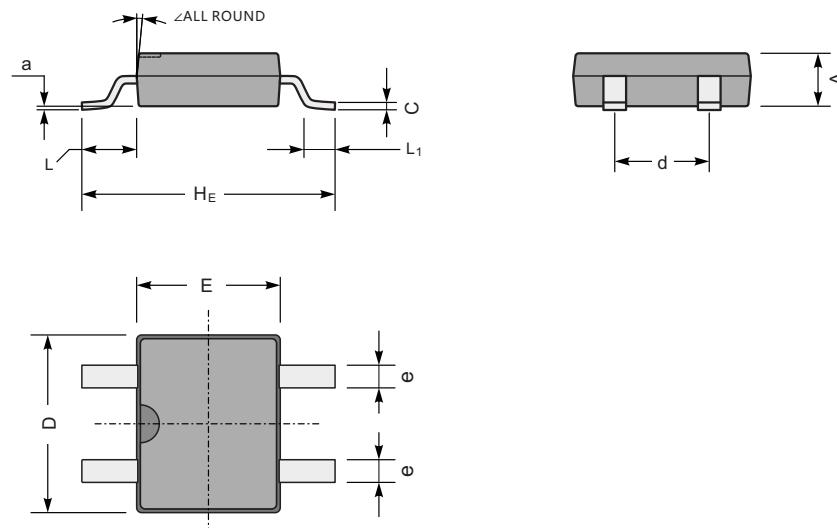
Fig.6- Typical Transient Thermal Impedance



Package Outline

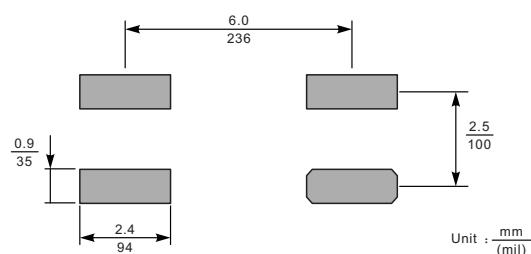
MBF

Plastic surface mounted package; 4leads



UNIT		A	C	D	E	H _E	d	e	L	L ₁	a	<
mm	max	1.6	0.22	5.0	4.1	7.0	2.7	0.8	1.7	1.1	0.2	7°
	min	1.2	0.15	4.5	3.6	6.4	2.3	0.5	1.3	0.5	—	
mil	max	63	8.7	197	161	276	106	31	67	43	8	7°
	min	47	5.9	177	142	252	91	20	51	20	—	

The recommended mounting pad size



Summary of Packing Options

Package	Packing Description	Packing Quantity	Industry Standard
MBF	Tape/Reel,13"reel	5000	EIA-481-1